

PLA Sparkle

• Basic Info

PLA is the most common material in 3D printing as it's easy to print and inexpensive. Meanwhile, its stiffness and strength can meet most printing needs. It is worth mentioning that it can biodegrade in some artificial composting conditions. Bambu PLA Sparkle is a nextlevel aesthetic filament that combines strength and sparkle. With metal particles included in its composition, Bambu PLA Sparkle adds a special sparkling look to your prints that sets them apart from the rest. However, it is not recommended to use a 0.2 mm nozzle for printing as clogging may occur.

• Specifications

Subjects	Data
Diameter	1.75 mm
Net Filament Weight	1 kg
Spool Material	ABS (Temperature resistance 70 °C)
Spool Size	Diameter: 200 mm; Height: 67 mm

• Recommended Printing Settings

Subjects	Data
Drying Settings before Printing	55 °C, 8 hours
Printing and Storage Humidity	< 20% RH (Sealed with desiccant)
Nozzle Temperature	190 - 230 °C
Bed Type	Cool Plate, High Temperature Plate or Textured PEI Plate
Bed Surface Preparation	PVP Glue
Bed Temperature	35 - 45 °C
Cooling Fan	100%
Printing Speed	< 250 mm/s
Retraction Length	0.6 - 1.0 mm
Retraction Speed	20 - 40 mm/s

Subjects	Data
Chamber Temperature	25 - 45 °C
Max Overhang Angle	55 °
Max Bridging Length	30 mm
Support Material	Support for PLA

• Properties

Bambu Lab has tested the differing aspects in the performance of PLA Sparkle material, including physical, mechanical, and chemical properties. Typical values are listed as followed:

Physical Properties			
Subjects	Testing Methods	Data	
Density	ISO 1183	1.26 g/cm ³	
Melt Index	210 °C, 2.16 kg	34.2 ± 3.3 g/10 min	
Melting Temperature	DSC, 10 °C/min	156 °C	
Glass Transition Temperature	DSC, 10 °C/min	56 °C	
Crystallization Temperature	DSC, 10 °C/min	N / A	
Vicar Softening Temperature	ISO 306, GB/T 1633	57 °C	
Heat Deflection Temperature	ISO 75 1.8 MPa	53 °C	
Heat Deflection Temperature	ISO 75 0.45 MPa	55 °C	
Saturated Water Absorption Rate	25 °C, 55% RH	0.44%	

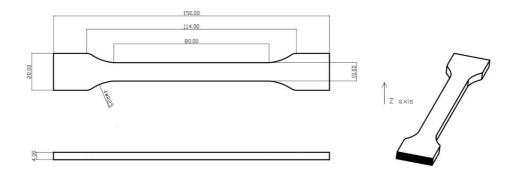
Mechanical Properties		
Subjects	Testing Methods	Data
Young's Modulus (X-Y)	ISO 527, GB/T 1040	1940 ± 230 MPa
Young's Modulus (Z)	ISO 527, GB/T 1040	1660 ± 210 MPa
Tensile Strength (X-Y)	ISO 527, GB/T 1040	39 ± 3 MPa
Tensile Strength (Z)	ISO 527, GB/T 1040	32 ± 2 MPa
Breaking Elongation Rate (X-Y)	ISO 527, GB/T 1040	11.7 ± 0.7 %
Breaking Elongation Rate (Z)	ISO 527, GB/T 1040	6.8 ± 0.6 %
Bending Modulus (X-Y)	ISO 178, GB/T 9341	2350 ± 140 MPa
Bending Modulus (Z)	ISO 178, GB/T 9341	2150 ± 110
Bending Strength (X-Y)	ISO 178, GB/T 9341	75 ± 4 MPa
Bending Strength (Z)	ISO 178, GB/T 9341	51 ± 2 MPa
Impact Strength (X-Y)	ISO 179, GB/T 1043	66.5 ± 3.6 kJ/m ² ; 23.2 ± 2.4 kJ/m ² (notched)
Impact Strength (Z)	ISO 179, GB/T 1043	10.3 ± 0.7 kJ/m ²

Other Physical and Chemical Properties		
Subjects	Data	
Odor	Odorless	
Composition	PLA	
Skin Hazards	No hazard	
Chemical Stability	Stable under normal storage and handling conditions	
Solubility	Insoluble in water	
Resistance to Acid	Not resistant	
Resistance to Alkali	Not resistant	
Resistance to Organic Solvent	Not resistant to some organic solvents	
Resistance to Oil and Grease	Resistant to most kinds of oil and grease	
Flammability	Flammable and self-extinguishing in the air	
Combustion Products	Water, carbon oxides	
Odor of Combustion Products	Odorless	

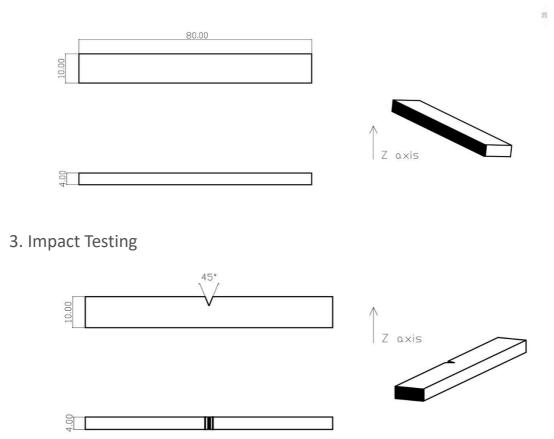
• Specimen Test

Specimen Printing Conditions			
Subjects	Data		
Nozzle Temperature	220 °C		
Bed Temperature	35 °C		
Printing Speed	200 mm/s		
Infill Density	100%		
*All the specimens were annealed and dried at 55 °C for 8 hours before testing.			

1. Tensile Testing



2. Bending Testing



• Disclaimer

The performance values are tested by standard samples at Bambu Lab, and the values are for design reference and comparison only. Actual 3D printing model performance is related to many other factors, including printers, printing conditions, printing models, printing parameters, etc.

In the process of using Bambu Lab 3D printing filaments, users are responsible for the legality, safety, and performance indicators of printing. Bambu Lab is not responsible for the use of materials and scenarios and is not responsible for any damage that occurs in the process of using our filaments.